

650V 30A Trench and Field Stop IGBT

JJT30N65SY

Key performance:

- $V_{\text{CE}}=650\text{V}$
- $I_{\rm C}=30{\rm A}@T_{\rm C}=100^{\circ}{\rm C}$
- $V_{\text{CE(sat)}}=1.7 \text{ V}$

Features:

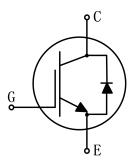
- High ruggedness performance.
- 10μs short circuit capability.
- Positive $V_{\text{CE (sat)}}$ temperature coefficient.
- High efficiency for motor control.
- Excellent current sharing in parallel operation.
- RoHS compliant.

Applications:

- Home appliances
- Motor drives
- General inverter







Package parameters

Туре	Marking	Package	Packaging method
JJT30N65SY	T3065SY	TO-220	Tube



Maximum ratings

Symbol	Parameter	Values	Unit
V_{CES}	Collector-emitter voltage	650	V
$V_{ m GES}$	Gate-emitter voltage	±20	V
ī	Continuous collector current (T _C =25°C)	60	A
I_{C}	Continuous collector current (T _C =100°C)	30	A
I_{CM}	Pulsed collector current, t_p limited by T_{vjmax}	120	A
$I_{ m F}$	Diode continuous forward current (T _C =100°C)	30	A
$I_{ m FM}$	Diode maximum current, t_p limited by T_{vjmax}	80	A
$t_{ m sc}$	Short circuit withstand time	10	μs
n	Power dissipation ($T_{\rm C}$ =25°C)	187	W
$P_{ m tot}$	Power dissipation ($T_{\rm C}$ =100°C)	93	W
$T_{ m vj}$	Operating junction temperature range	-40 to +175	°C
$T_{ m stg}$	Storage temperature range	-55 to +150	°C

Thermal characteristics

Symbol	D	Values		TT
	Parameter	Тур.	Max.	Unit
$R_{ m th(j-c)}$	Thermal resistance, junction to case for IGBT	-	0.8	K/W
$R_{ m th(j-c)}$	Thermal resistance, junction to case for Diode	-	1.8	K/W
$R_{ m th(j-a)}$	Thermal resistance, junction to ambient	-	40	K/W



Electrical characteristics of IGBT $(T_{vj}=25^{\circ}\text{C} \text{ unless otherwise specified})$

Static characteristics

Cymhal	D	70. 4 114	Values			TT . *4
Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
$BV_{\rm CES}$	Collector-emitter breakdown voltage	$V_{\rm GE} = 0 \text{V}, I_{\rm C} = 250 \mu \text{A}$	650	-	-	V
I_{CES}	Collector-emitter leakage current	$V_{\rm CE}$ =650V, $V_{\rm GE}$ =0V	-	-	50	μА
I	Gate leakage current, forward	$V_{\rm GE} = 20 \text{V}, \ V_{\rm CE} = 0 \text{V}$	-	-	100	nA
$I_{ m GES}$	Gate leakage current, reverse	$V_{\rm GE}$ =-20V, $V_{\rm CE}$ =0V	-	-	-100	nA
$V_{\mathrm{GE(th)}}$	Gate-emitter threshold voltage	$V_{\rm GE} = V_{\rm CE}, I_{\rm C} = 1 \mathrm{mA}$	5.3	5.7	5.9	V
T/		$V_{\rm GE} = 15 \text{V}, I_{\rm C} = 30 \text{A}$	-	1.7	-	V
V _{CE(sat)}	Collector-emitter saturation voltage	$V_{\text{GE}} = 15\text{V}, I_{\text{C}} = 30\text{A}, T_{\text{vj}} = 175^{\circ}\text{C}$	-	2.2	-	V

Dynamic characteristics

C 1	Daniero Arri	Tr. 4 . 1'4'	Values			II
Symbol	Parameter	Test condition		Тур.	Max.	Unit
C_{ies}	Input capacitance	$V_{\rm CE}$ =30V	-	1978	1	pF
$C_{ m oes}$	Output capacitance	$V_{\rm GE}=0{ m V}$	-	100	-	pF
$C_{\rm res}$	Reverse transfer capacitance	f=1MHz	-	23	-	pF
$Q_{ m g}$	Total gate charge	V_{CC} =520V V_{GE} =15V I_{C} =30A	-	103	-	nC



Switching characteristics

6 1 1	bol Parameter Test conc	TD 4 114	Values			TT .*4
Symbol		Test condition	Min.	Тур.	Max.	Unit
$t_{ m d(on)}$	Turn-on delay time		-	30	-	ns
$t_{ m r}$	Rise time		-	39	-	ns
$t_{ m d(off)}$	Turn-off delay time	$V_{\rm CC}$ =400V $V_{\rm GE}$ =0/15V	-	151	-	ns
$t_{ m f}$	Fall time	$I_{C}=30A$ $R_{G}=10\Omega$	-	29	-	ns
$E_{ m on}$	Turn-on energy	Inductive load	-	0.95	-	mJ
$E_{ m off}$	Turn-off energy	1	-	0.60	-	mJ
E_{ts}	Total switching energy		-	1.55	-	mJ
t _{d(on)}	Turn-on delay time		-	28	-	ns
$t_{ m r}$	Rise time	$V_{\rm CC}$ =400V	-	40	-	ns
$t_{ m d(off)}$	Turn-off delay time	$V_{\rm GE} = 0/15 { m V}$	-	169	-	ns
$t_{ m f}$	Fall time	$I_{C}=30A$ $R_{G}=10\Omega$ Inductive load $T_{vj}=175^{\circ}C$	-	71	-	ns
$E_{ m on}$	Turn-on energy		-	1.5	-	mJ
$E_{ m off}$	Turn-off energy		-	0.8	-	mJ
$E_{ m ts}$	Total switching energy		-	2.3	-	mJ



Electrical characteristics of Diode $(T_{vj}=25^{\circ}\mathbb{C} \text{ unless otherwise specified})$

Ch - l	Development	T-4 - 1'4'	Values			II:4
Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
IV.	Die de ferryand velte ce	$I_{\rm F}$ =30A	-	1.4	-	V
$V_{ m F}$	Diode forward voltage	$I_{\rm F}=30{\rm A}, T_{\rm vj}=175{}^{\circ}{\rm C}$	-	1.2	-	V
$t_{ m rr}$	Diode reverse recovery time	$V_{ m R}$ =400V	-	105	-	ns
$I_{ m rrm}$	Diode peak reverse recovery current	$I_{F}=30A$ $di_{F}/dt=-550A/\mu s$	-	16	-	A
$Q_{ m rr}$	Diode reverse recovery charge		-	876	-	nC
$t_{ m rr}$	Diode reverse recovery time	$V_{\rm R}$ =400V	-	171	-	ns
$I_{ m rrm}$	Diode peak reverse recovery current	$I_{\rm F}$ =30A d $i_{\rm F}$ /d t =-550A/ μ s	1	26	-	A
$Q_{ m rr}$	Diode reverse recovery charge	$T_{ m vj}$ =175°C	-	2650	-	nC



Typical performance characteristics

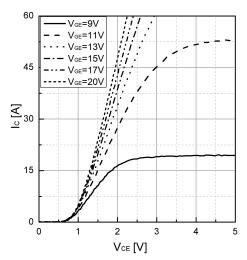


Fig 1. Typical output characteristic (T_{vj} =25°C)

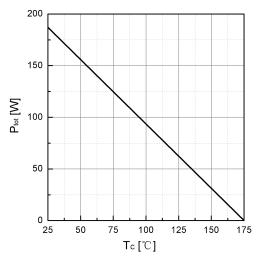


Fig 3. Power dissipation as a function of T_C

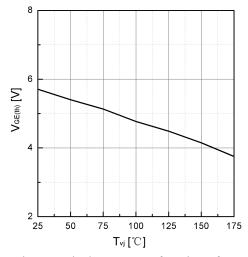


Fig 5. Typical $V_{GE(th)}$ as a function of T_{vj} ($I_C=1 \text{ mA}$)

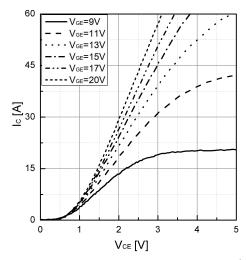


Fig 2. Typical output characteristic(T_{vj} =175°C)

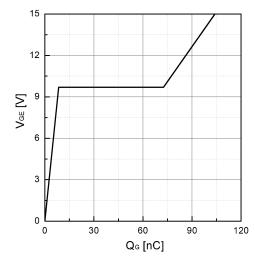


Fig 4. Typical Gate charge

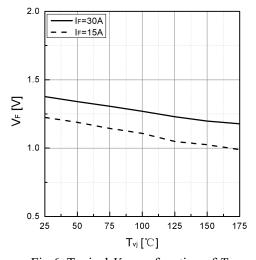


Fig 6. Typical V_F as a function of T_{vj}



Typical performance characteristics

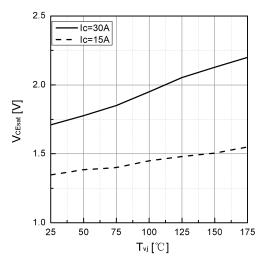


Fig 7. Typical V_{CEsat} as a function of T_{vj}

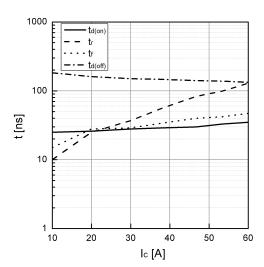


Fig 9. Typical switching time as a function of $I_{\rm C}$

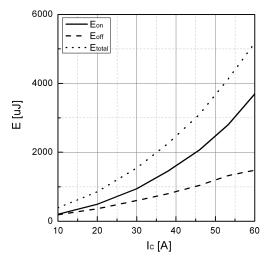


Fig 11. Typical switching energy losses as a function of $I_{\mathbb{C}}$

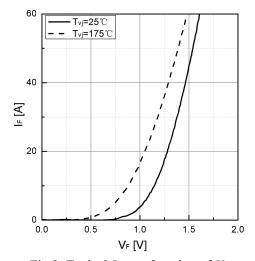


Fig 8. Typical I_F as a function of V_F

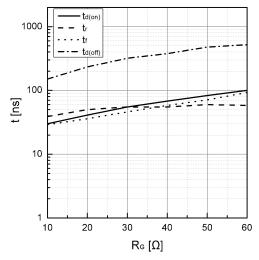


Fig 10. Typical switching times as a function of R_G

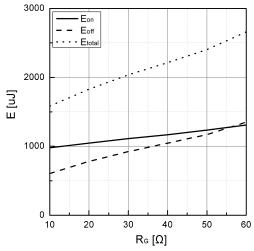


Fig 12. Typical switching energy losses as a function of R_G



Typical performance characteristics

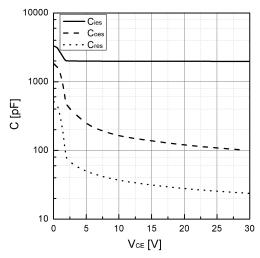
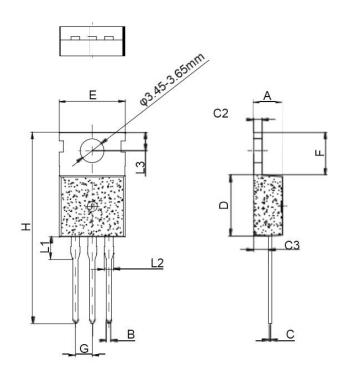


Fig 13. Typical capacitance as a function of $V_{\rm CE}$ (f=1Mhz, $V_{\rm GE}$ =0V)



Package dimension

TO-220



			Dime	ensions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
A	4.40	-	4.60	0.173	-	0.181
В	0.70		0.90	0.028		0.035
С	0.45		0.60	0.018		0.024
C2	1.23		1.32	0.048		0.052
С3	2.20		2.60	0.087		0.102
D	8.90		9.90	0.350		0.390
Е	9.90		10.3	0.390		0.406
F	6.30		6.90	0.248		0.272
G		2.54			0.100	
Н	28.0		29.8	1.102		1.173
L1		3.39			0.133	
L2	1.14		1.70	0.045		0.067
L3	2.65		2.95	0.104		0.116



Revision history

Date	Revision	Changes
2024-06-03	Rev 1.0	Release of the datasheet

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